



SP01-302

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Karl Heinz Buchanan, et al

Serial No: 10/035659

Examiner: John Hoffman

Filed: October 26, 2001

Group Art Unit: 1731

For: DIRECT BONDING OF GLASS
ARTICLES FOR DRAWINGINFORMATION DISCLOSURE STATEMENT
UNDER 37 C.F.R. §§ 1.56, 1.97 – 1.98Mail Stop Amendment
Commissioner of Patents
Alexandria, VA 22313-1450

Dear Sir:

The Examiner's attention is hereby directed to the following reference(s) listed on the attached Form PTO-1449 for consideration in connection with the examination of the above-identified patent application. One copy of the reference is enclosed.

Each of the enclosed reference(s) was cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this information disclosure statement.

This submission does not represent that a search has been made or that no better art exists and does not constitute an admission that each or all of the enclosed documents constitute "prior art." If it should be determined that any of the submitted documents do not constitute "prior art" under United States law, applicant(s) reserve the right to present to the office the relevant facts and law regarding the appropriate status of such documents.

Applicant(s) further reserve the right to take appropriate action to establish the patentability of the disclosed invention over the enclosed references, should one or more of the references be applied against the claims of the present application.

Respectfully submitted,

Siwen Chen
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Date: March 17, 2002

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to Mail Stop Amendment, Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on 3-17-02
Date of Deposit

Jennifer Kazukiewicz
Name of applicant, assignee, or
Registered Representative

Signature

3-17-02

Date of Signature

FORM PTO-1449 (MODIFIED)

ATTORNEY DOCKET NO.

SERIAL NO.

LIST OF PATENTS AND
PUBLICATIONS

SP01-302

10/035659

FOR APPLICANTS INFORMATION
DISCLOSURE STATEMENT

APPLICANT Karl Heinz Buchanan, et al.

FILING DATE
October 26, 2001

GROUP: 1731

REFERENCE DESIGNATION

U.S. PATENT DOCUMENTS

Examiner Initial		Document Number	Date	Name	Class	Sub- Class	Filing Date if Approp.
	AA						
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						

FOREIGN PATENT DOCUMENTS

		Document Number	Date	Country	Class	Sub- Class	Translation Yes No
	AL						
	AM						
	AN						
	AO						
	AP						
	AQ						

OTHER ART (Including Author, Title, Date, Pertinent Pages, etc.)

	AR	W.P. Maszara, "Silicon-On-Insulator by Wafer Bonding: A Review" J. Electrochemical Society, Inc., Vol. 138, No.1, January 1991
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EXAMINER:

DATE CONSIDERED:

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609: draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.